506516705 02/22/2021

PATENT ASSIGNMENT COVER SHEET

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 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ARVIND CHOKHANI	02/18/2021
JOSEPH MICHAEL SWENTON	02/18/2021
SANTOSH SUBHASCHANDRA MALAGI	02/18/2021

RECEIVING PARTY DATA

Name:	CADENCE DESIGN SYSTEMS, INC.
Street Address:	2655 SEELY AVENUE
City:	SAN JOSE
State/Country:	CALIFORNIA
Postal Code:	95134

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17181470

CORRESPONDENCE DATA

Fax Number: (216)621-4072

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: TAROLLI, SUNDHEIM, COVELL & TUMMINO, LL

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ATTORNEY DOCKET NUMBER: CDS-030068 US NPR

NAME OF SUBMITTER: MICHAEL R STEEL

SIGNATURE: /Michael R Steel/

DATE SIGNED: 02/22/2021

Total Attachments: 2

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PATENT 506516705 REEL: 055354 FRAME: 0672

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Cadence Design Systems, Inc., a corporation organized and existing under the laws of the Country of the United States of America, with a place of business at 2655 Seely Avenue, San Jose, California 95134, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said Cadence Design Systems, Inc., its successors and assigns, my/our entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefore, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said Cadence Design Systems, Inc., as assignee of my entire right, title and interest.

I also hereby sell and assign to Cadence Design Systems, Inc., its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said Cadence Design Systems, Inc., or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said Cadence Design Systems, Inc., its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I hereby further authorize and direct the attorneys of record to insert the serial number and filing date of said application now identified by the attorney docket number and title set forth above as soon as the same shall have been made known to them by the United States Patent and Trademark Office.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	FAULT RULES FILES FOR TESTING AN IC CHIP	
NONPROVISIONAL APPLICATION NO.	FILING DATE	

SIGNATURE OF INVENTOR	A Characteristics
PRINTED NAME OF INVENTOR	Arvind Chokhani
DATE	Feb 18, 2021
RESIDENCE (CITY AND COUNTRY)	Murphy, Texas, United States of America

SIGNATURE OF INVENTOR	A 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
PRINTED NAME OF INVENTOR	Joseph Michael Swenton
DATE	Feb 18, 2021
RESIDENCE (CITY AND COUNTRY)	Owego, New York, United States of America

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Santosh Subhaschandra Malagi
DATE	Feb 18, 2021
RESIDENCE (CITY AND COUNTRY)	Endicort, New York, United States of America